## Features

- Frequency Range 4.9 GHz to 5.9 GHz
- Supply-voltage 2.7 V to 3.6 V
- 2.5% EVM at 19 dBm Output Power at 54 Mbit/s OFDM
- 26.5 dB P<sub>1dB</sub>
- On-chip Power Detector with 20 dB Dynamic Range
- Power-down Mode and Biasing Control
- Low Profile Lead-free Plastic Package QFN16 (4  $\times$  4  $\times$  0.9 mm)

### **Applications**

- IEEE 802.11a OFDM WLAN
- Hiperlan2 WLAN
- PC Cards, PCMCIA
- 5 GHz ISM Band Application

Electrostatic sensitive device. Observe precautions for handling.



## Description

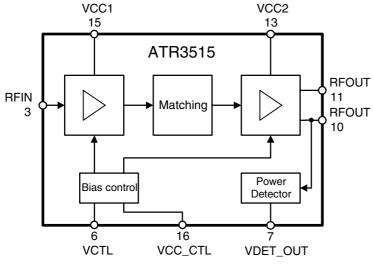
#### Process

The 5-GHz power amplifier is designed in Atmel's advanced Silicon-Germanium (SiGe) process and provides excellent linearity and noise performance as well as good power-added efficiency.

#### Circuitry

The PA consists of a two-stage amplifier with a  $P_{1db}$  of 26 dBm. The output stage was realized using an open-collector structure. Power-up/down and output level are controlled at bias control pin 6 (VCTL). An on-chip power detector provides a voltage proportional to the output power.

Figure 1. Block Diagram







5-GHz WLAN Power Amplifier for 802.11a

## ATR3515

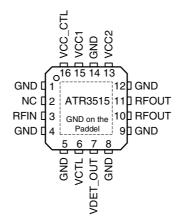
## Preliminary

Rev. 4514H-WLAN-12/03

# <u>AIMEL</u>

## **Pin Configuration**

Figure 2. Pinning QFN16



## **Pin Description**

Pin	Symbol	Function
1	GND	Ground
2	NC	Not connected
3	RFIN	RF input
4	GND	Ground
5	GND	Ground
6	VCTL	Power-up/biasing control voltage
7	VDET_OUT	Power detector output voltage
8	GND	Ground
9	GND	Ground
10	RFOUT	RF output
11	RFOUT	RF output
12	GND	Ground
13	VCC2	Supply voltage for PA stage
14	GND	Ground
15	VCC1	Supply voltage for driver stage
16	VCC_CTL	Supply voltage for biasing control
Paddel	-	Ground

## <sup>2</sup> ATR3515 [Preliminary]

## **Absolute Maximum Ratings**

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Parameters	Pin	Symbol	Value	Unit
Farameters	FIII	Symbol	value	Unit
Supply voltage		V <sub>CC</sub>	3.8	V
Supply current		I <sub>CC</sub>	800	mA
Junction temperature		Tj	150	°C
Storage temperature		T <sub>Stg</sub>	-40 to +125	°C
Input RF power		P <sub>IN</sub>	12	dBm
Control voltage power up/down and biasing		V <sub>CTL</sub>	0 to 2.0	V

Note: The part may not survive all maximums applied simultaneously.

## **Operating Range**

Parameters	Symbol	Value	Unit
Supply voltage range	V <sub>CC</sub>	2.7 to 3.6	V
Ambient temperature range	T <sub>amb</sub>	-25 to +75	°C

## **Electrical Characteristics**

No.	Parameters	Test Conditions	Pin	Symbol	Min.	Тур.	Max.	Unit	Type*
1.0	Supply voltage			V <sub>CC</sub>	2.7	3.3	3.6	V	Α
1.1	Frequency range			f	4.9		5.9	GHz	А
1.2	Control voltage range	PA operating mode		V <sub>CTL</sub>	1.3		1.9	V	А
1.3	- Control voltage range	Power down mode		V <sub>CTL</sub>			0.2	V	А
1.4	Control current	PA Operation		I <sub>CTL</sub>			200	μA	А
1.5	Current consumption	Quiescent		lcq		180		mA	А
1.6	Current consumption	Power down mode		lpd			10	μA	А
1.7	Turn on/off time	ON is the time that ICC returns to normal and OFF is the time the current needs to decrease to 10% of normal mode		t <sub>on/off</sub>		0.5	0.6	μs	с
1.8	Input and output return loss	With external matching				-12	-8	dB	С
1.9		At ±11 MHz offset from carrier					-22	dBr	В
1.10	Spectrum mask <sup>(1)</sup>	At ±20 MHz offset from carrier					-30	dBr	В
1.11		At ±30 MHz offset from carrier					-42	dBr	В

\*) Type means: A = 100% tested, B = 100% correlation tested, C = Characterized on samples, D = Design parameter

Note: 1. OFDM signal according to 802.11a specification with  $P_{out} = 21 \text{ dBm}$  at 54 Mbps.





## **Electrical Characteristics - Unmodulated Carrier**

Test Conditions (unless otherwise stated):  $V_{CC}$  = 3.3 V, Frequency = 5.25 GHz,  $T_{amb}$  = 25°C

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No.	Parameters	Test Conditions	Pin	Symbol	Min.	Тур.	Max.	Unit	Type*
2.0	Saturated output power	For reference		Psat		28		dBm	Α
2.1	P1dB output power			P1dB		26.5		dBm	А
2.3	Small signal gain	lcq = 180 mA, small signal condition		GL		18		dB	А
2.4	Gain deviation	Within 200 Mhz frequency band		Gd	-1		+1	dB	А
2.5	Reverse isolation			ISOr	30	36		dB	С

\*) Type means: A = 100% tested, B = 100% correlation tested, C = Characterized on samples, D = Design parameter

## **Electrical Characteristics - 54 Mbps OFDM-modulation**

Test Conditions (unless otherwise stated):  $V_{CC} = 3.3 \text{ V}$ , Frequency = 5.25 GHz,  $T_{amb} = 25^{\circ}$ C, IEEE802.11a conform 54 Mbps OFDM modulation, EVM measurement equipement noise floor included in EVM measurement result .

No.	Parameters	Test Conditions	Pin	Symbol	Min.	Тур.	Max.	Unit	Type*
3.0	Error vector magnitude	P <sub>OUT</sub> = 19 dBm		EVM		2.5		%	С
3.1	Linear power gain	P <sub>OUT</sub> = 19 dBm		GL		20		dB	С
3.2	Current consumption	P <sub>OUT</sub> = 19 dBm		I <sub>CC</sub>		240		mA	А

\*) Type means: A = 100% tested, B = 100% correlation tested, C = Characterized on samples, D = Design parameter

#### **Electrical Characteristics - Power Detector**

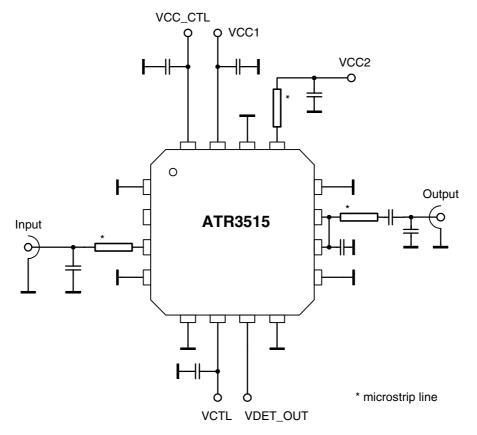
Test Conditions (unless otherwise stated):  $V_{CC} = 3.3$  V, Frequency = 5.25 GHz,  $T_{amb} = 25^{\circ}C$ .

No.	Parameters	Test Conditions	Pin	Symbol	Min.	Тур.	Max.	Unit	Type*
4.0	Detector voltage range	P <sub>OUT</sub> = 2 to 28 dBm		V <sub>DET</sub>	0		2.4	V	А
4.2	Settling time			tset		0.5		μs	С

\*) Type means: A = 100% tested, B = 100% correlation tested, C = Characterized on samples, D = Design parameter

## ATR3515 [Preliminary]

#### Figure 3. Application Circuit





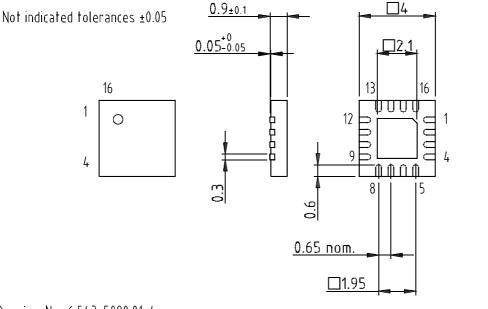


## **Ordering Information**

Extended Type Number	Package	Remarks
ATR3515-PEP	QFN16 - 4x4	Taped and reeled, MOQ 1,500
ATR3515-PEQ	QFN16 - 4x4	Taped and reeled, MOQ 6,000

## **Package Information**

Package: QFN 16 - 4x4 Exposed pad 2.1x2.1 (acc. JEDEC OUTLINE No. MO-220) Dimensions in mm





technical drawings according to DIN specifications

Drawing-No.: 6.543-5090.01-4 Issue: 2; 24.01.03



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